





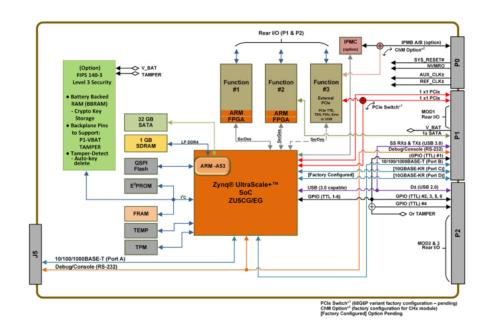




68G6 3U OpenVPX Multifunction I/O Boards 3U OpenVPX SOSA™-Aligned MFIO-Intensive Processing Board

The **68G6** is a **SOSA™-Aligned** 3U OpenVPX board that can be configured with up to three NAI smart I/O and communication function modules. In addition to the standard expansion plane (EP) PCle and control plane (CP) Ethernet control interfaces, the 68G6 facilitates convenient external access to supported NAI PCIe function modules through its 1 x1 PCIe interface, enabling seamless expansion of host SBC functions for enhanced project solutions, while also offering external access to supported NAI FMx modules via a SATA II interface. The 68G6 is on NAI's certifiable product development roadmap supporting DO-178C and DO-254 design assurance guidelines for safety-critical applications. Ideally suited for rugged Mil-Aero applications, the 68G6 delivers off-the-shelf solutions that accelerate deployment of SWaP-optimized systems in air, land and sea applications.





Features

- 3U SOSA™-Aligned/VITA 65 OpenVPX Profile

 - SLT3-PAY-2U2U-14.2.17
 MODA3p-16.2.16-1-F2C-(P3U)(2E7)
- Data and Control Interfaces
 - Expansion Plane (P1):
 - 1 x1 PCle Gen 3 (EPutp01, wafer 1) (for motherboard/modules) Endpoint default, Root Complex optional
 - 1 x1 PCle Gen 3 (EPutp02, wafer 2) (for module 3, direct external PCIe interface OR 2nd PCIe x1 motherboard control, pending)
 - Control Plane (P1) (TSN Planned):
 - 2x 10GBase-KR
- IPMC Support (configured option)
 - VITA 46.11 Tier-2 basic compatible

- **Advanced Security Options**
 - FIPS 140-3 Layer 3 Hardware Support, Secure Boot
- **Dual or Quad Core ARM -53 Endpoint** w/Local Processing (Root Complex, Optional)
 - 1.2 GHz (max)
 - 1 GB LPDDR4 & 32 GB SATA Flash
- Supports Three NAI smart I/O function
 - SerDes interface to function module slots 1, 2 or 3
- Independent external 1 x1 PCIe interface to function module slot 3 - 68G6P variant board; for use with modules requiring high-speed routing including Ethernet and chassis management [CH1] functions (pending option with 2nd PCle x1 control lane on EPutp02)
- Independent external SATA interface to function module slot 2

- Continuous background Built-In Test (BIT)
- As applicable for supported functions
- Peripheral I/O (all I/O is rear accessed)
- USB 3.0, 6x TTL GPIO, RS-232 Debug/Console
- Software Support Kit (SSK)
 - API libraries, documentation, sample and source code
 - RTOS support for DDCI-Deos™, Wind River® VxWorks® HVP, Green Hills INTEGRITY-178 tuMP (contact factory)
- Commercial or Rugged Applications Operating **Temperatures**
 - Commercial: 0°C to 70°C
 - Rugged: -40°C to 85°C Conduction and air-cooled options
- Power
 - +12V (VS1) and +3.3_AUX only
 - <11W (est. typical), not including module power
- Mechanical (ANSI/VITA 48.1, 48.2)
 - 3U, 5HP/1.0" pitch (air or conduction-cooled)



Select up to 3 independent functions for your application

				I/O Modules		
Function	Module	Description		Function	Module	Description
	AD1	12 CH. A/D, ±10 V, Dedicated, 256 kHz (max), Sigma-Delta		Digital-to-Analog	DA5	4 CH. D/A, High-Voltage/High-Current Half-Bridge (2 Channels Full-Bridge) External VCC Sourced Outputs
	AD2	12 CH. A/D, ±100 V (max), Dedicated, 256 kHz (max), Sigma-Delta		Digital IO - Differential Transceiver	DF1	16 CH. Differential I/O, Input: -10 V to +10 V (422), -7 V to +12 V (485) Output:25 V to +5 V
Analog-to-Digital	AD4	16 CH. A/D, ± 10 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR			DF2	16 CH. 16 Channel Enhanced Differential I/O
	AD5	16 CH. A/D, ± 50 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR		Discrete IO - Multichannel, Programmable	DT1	24 CH. Discrete I/O, 0-60 VDC Input/Output, Max lout 500 mA - 2 A, Source/Sink (out)
	AD6	16 CH. A/D, ± 100 V, Multiplexed, 500 KHz Agg / 8 Ch, SAR			DT2	16 CH. Discrete I/O, ±80 V Input/Output, Max lout 600 mA, Isolated/Cł Switch (out)
	<u>ADE</u>	16 CH. A/D, ±10 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling			DT4	24 CH. Enhanced DT1
	<u>ADF</u>	16 CH. A/D, ±100 V, Individual 16-bit SAR, 200 kHz max., Simultaneous Sampling			DT5	16 CH. Enhanced DT2
Chip Detector and Fuzz Burn	CD1	6 CH. Chip Detector (CD) and Fuzz Burn (FB)			RY1	4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Non Latching
Digital-to-Analog	DA1	12 CH. D/A, ± 10 V, 25 mA Per Channel, Current or Voltage Control		Relay	RY2	4 CH. Relay, 220V/2A @ 60W/62.5VA (Max), Latching
	DA2	16 CH. D/A, ± 10 V, 10 mA Per Channel, No Current Control		Digital IO - TTL/CMOS	TL1	24 CH. TTL I/O, Standard Functionality, Programmable
	DA3	4 CH. D/A, ±40 V, ±100 mA, Voltage or Current Output			TL2	24 CH. TTL I/O, Enhanced Functionality, Programmable
	DA4	4 CH. D/A, ± 20 to ± 80, 10 mA, Voltage Control Only		Variable Reluctance	VR1	8 CH. Variable Reluctance Signal Input and General-Purpose Pulse Counter, ±100 V, 100 kHz (max)
		Measurem	1e	nt & Simulation Mod	ules	
Function	Module	Description		Function	Module	Description
AC Reference	AC2	2 CH. AC Reference Source, 47 Hz - 20 KHz, ± 3% Acc, 2 – 28 Vrms, 6 VA (Max/Ch) Power		Synchro Resolver	DSx (DRx)	1 - 3 CH. Digital to Synchro/Resolver, 2 - 90 VLL, 2 - 115 Vrms Exc, 47 Hz - 20 kHz Freq
	AC3	2 CH. AC Reference Source, 47 Hz - 2.5 KHz, ± 3% Acc, 28 – 115 Vrms, 6 VA (Max/Ch) Power		Measurement and Simulation	SDx	4 CH. Synchro/Resolver to Digital, 2 - 90 Vrms Input, 2 - 115 Vrms Exc 47 Hz to 20 kHz Freq
LVDT RVDT Measurement and Simulation	<u>DLx</u>	1 - 3 CH. Digital to LVDT/RVDT, 2 - 90 Vrms Full Scale, 2 - 115 Vrms Exc, 47 Hz - 20 kHz Freq		Pulse Timer Receiver and Generator	PT1	2 CH. Pulse Timer 1-PPS &/or 10 MHz Input with Multiple Outputs and 2 Channels Isolated RS-422/485 Serial Communications
	LD1	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 47 Hz -1 KHz Freq		Thermocouple and RTD Measurement	RT1	8 CH. Resistance Temperature Detectors (RTD), 2, 3, or 4 wire, 16 Bit Res, 16.7 Hz/Ch
	LD2	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 1 KHz - 5 KHz Freq			TC1	8 CH. Thermocouple, 4.17 - 470 Hz, ±100 mV A/D
	LD3	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 5 KHz - 10 KHz Freq			TR1	8 CH. Thermocouple (TCx) & Resistance Temperature Detectors (RTD), programmable per channel
	LD4	4 CH. LVDT/RVDT to Digital, 2-28 Vrms Input, 2-115 Vrms Exc, 10 KHz - 20 KHz Freq		Strain Gauge Measurement	<u>SG1</u>	4 CH. Strain Gauge, 4.7 Hz - 4.8 KHz, Measurement, Conventional 4-Arm Bridge
	LD5	4 CH. LVDT/RVDT to Digital, 28-90 Vrms Input, 2- 115 Vrms Exc, 47 Hz - 1 KHz Freq				



Communication Modules											
Function	Module	Description		Function	Module	Description					
ARINC Communications	AR1	12 CH. ARINC 429, 100 KHz or 12.5 KHz, RX/TX, 256 Word Tx/Rx Buffer	•	MIL-STD-1553B	FTC	4 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled					
CANBus Communications	<u>CB1</u>	8 CH. CANBus, CAN 2.0 A/B, 16 K RX/TX Buffer, 1 Mb/s Max Data Rate (G6-M1)		Serial Communications	SC3	8 CH. (max) RS-232/422/485 Serial Communications or GPIO, Programmable, Non-isolated					
	<u>CB2</u>	8 CH. CANBus, J1939, 16 K RX/TX Buffer, 500 kb/s Max Data Rate (G6-M1)			SC5	4 CH. RS-232/422/485 communications, isolated per channel and from SYS GND					
	CB3	8 CH. CANBus, CAN 2.0 A/B (CB1) or J1939 (CB2) protocol layer programmable per channel (G6-M1)			SC6	4 CH. RS-232/422/485 communications, individual SYS GND provided per channel (non-isolated)					
MIL-STD-1553B	<u>FTA</u>	1 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM, Transformer Coupled	•	Time Sensitive Networking	<u>TN1</u>	1 CH. Single Channel, Tri-Redundant Ports, TSN, IEEE 802.1AS, End Point, DornerWorks IP					
	<u>FTB</u>	2 CH. MIL-STD-1553 (AMC), BC, RT, BM, BM/RT, 128 KB RAM Per Channel, Transformer Coupled									
Storage											
Function	Module	Description		Function	Module	Description					
SATA Solid State Drive (SSD)	FM2	1 CH. 480 GB MLC SATA Flash, extended temp -40°C to 85°C operation		SATA Solid State Drive (SSD)	FM8	1 CH. 1 TB SATA TLC NAND Flash, Extended Temperature Operation					
	<u>FM7</u>	1 CH. 1 TB SATA Flash, 3D NAND MLC, 0-70 °C operation			FM9	1 CH. 1.92 TB SATA TLC NAND Flash, Extended Temperature Operation					
		Combina	at	ion Modules							
Function	Module	Description		Function	Module	Description					
Combo	CM2	8 CH. ARINC 429 (100 KHz or 12.5 KHz, RX/TX, 256 Word Tx/Rx Buffer) & 12 Ch. Discrete I/O		Combo	<u>CME</u>	8 CH. ±10V A/D (ADE-type) & 8 Channels ±10V D/A (DA2-type), Combination					
	CM4	2 CH. 4 Ch. RS-422/485 ASYNC (TX±/RX±) & 12 Channel Discrete I/O, 0-60 VDC Input/Output, Max lout 500 mA - 2 A, Source/Sink (out)			<u>CMF</u>	8 CH. ±100V A/D (ADF-type) & 8 Channels ±10V D/A (DA2-type), Combination					
	<u>CM5</u>	2 CH. Dual-redundant MIL-STD-1553 & 8 Channel ARINC 429/575, 100 KHz or 12.5 KHz, RX or TX, 256 Word Tx/Rx Buffer			<u>CMH</u>	5 CH. Serial Comms: 1 Ch. RS-232 ASYNC w/flow (TX/RX/CTS/RTS), 4 Ch. RS-422/485 ASYNC (TX±/RX±) & 6 Ch. Differential RS-422/485 I/O (DF1-type)					
	<u>CM8</u>	2 CH. Dual-redundant MIL-STD-1553 & 12 Channel Discrete I/O, 0-60 VDC Input/Output, Max lout 500 mA - 2 A, Source/Sink (out)									
Chassis Management (ChM)											
Function	Module	Description		Function	Module	Description					
Chassis Management	CH1	1 CH. Chassis Management Controller (ChMC), VITA 61 XMC, VITA 46.11, IPMB I/F, 1000BASE-T for System Management Communications	•								

Architected for Versatility

NAI's Configurable Open Systems Architecture™ (COSA®) offers a choice of over 100 smart I/O, communications, or Ethernet switch functions, providing the highest packaging density and greatest flexibility of ruggedized embedded product solutions in the industry. Preexisting, fully-tested functions can be combined in an unlimited number of ways quickly and easily.

One-Source Efficiencies

Eliminate man-months of integration with a configured, field-proven system from NAI. Specification to deployment is a seamless experience as all design, state-of-the-art manufacturing, assembly and test are performed - by one trusted source. All facilities are located within the U.S. and optimized for high-mix/low volume production runs and extended lifecycle support.

Product Lifecycle Management

From design to production and beyond, NAI's product lifecycle management strategy ensures the long-term availability of COTS products through configuration management, technology refresh and obsolescence component purchase and storage.

Made in the USA Certified Small Business

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